

Isolated DC/DC Converters ICs

Built-in Automotive Switching MOSFET Isolated Flyback Converter ICs BD7F205EFJ-C Evaluation Board

BD7F205EFJ-EVK-001

Overview

This evaluation board outputs an isolated 6.2 V, 16.5 V and 6.2 V voltage from an input of 8 V to 32 V, and can output a maximum output power 6 W.

BD7F205EFJ-C is an isolated flyback converter that does not require a photocoupler.

Feedback circuit by the transformer's tertiary winding or photocouplers becomes unnecessary, contributing to reduction of set parts.

It also has a number of built-in protection functions that enable the design of isolated power supply applications for high reliability.

Figure 1. BD7F205EFJ-EVK-001

Performance Specifications

This is a typical value and does not guarantee the characteristics.

Operating Procedure

1. Necessary equipment

- (1) DC power supply of V to 32 V, 10 W / 5 A or more
- (2) Load device up to 5 W
- (3) DC voltmeter

2. Connecting the Equipment

- (1) Preset the DC power supply to 8 V to 32 V and turn off the power output.
- (2) Set the load to less than or equal to the rated current of each output and disable the load.
- (3) Connect the positive terminal of the power supply to the VIN terminal and the negative terminal to the GND terminal with a pair of wires.
- (4) Connect the positive terminal of the load to VOUT terminal and the negative terminal to GND terminal with a pair of wires.
- (5) When connecting a wattmeter, connect as shown below. (Refer to your power meter User's Manual for more information)
- (6) Connect the positive terminal of the DC voltmeter to VOUT terminal and the negative terminal to GND terminal for measuring the output voltage.
- (7) Turn on the output of the DC power supply.
- (8) Check that the DC voltmeter display is at the set voltage.
- (9) Activates the load.

Figure 2. Connection Diagram

Application circuit

The evaluation board operates with an average frequency of approximately 363 kHz.

Monitoring the flyback voltage due to the voltage at the output provides primary-side feedback control that eliminates the need for photocouplers and auxiliary windings.

Operation starts when the VIN pin voltage exceeds UVLO detect voltage of 3.4 V (Typ) and SDXEN pin Enable pin voltage of 2.0 V (Typ).

The circuit diagram of the demonstration board is shown in the figure below, and the parts list is shown on page 12.

Figure 3. Circuit diagram

Outline of BD7F205EFJ-C

Features

- AEC-Q100 (Grade-1)
- No Need for Optocoupler and Third Winding of **Transformer**
- Output voltage is set by two external resistors and transformer winding ratio.
- Uses proprietary adaptive ON-time control technology
- Highly efficient light load mode (PFM operation)
- Shutdown and Enable control
- Burst voltage design possible
- 60 V Built-in-switching MOSFET
- Spread frequency spectrum
- Soft start function
- Load current compensation function
- Various protection functions Undervoltage protection (UVLO) Overcurrent protection (OCP)

Overheat protection (TSD)

REF pin open protection (REFOPEN)

Short-circuit protection (SCP)

Battery short-circuit protection (BSP)

Pin Layout

Critical Characteristics

Package W (Typ) x D (Typ) x H (Max)

HTSOP-J8 4.9 mm x 6.0 mm x 1.0 mm

Applications

Insulated power supply for automotive use (E-Comp, Inverter etc)

Insulated power supply for industrial equipment

PIN ASSIGNMENT

Measurement data

1. Load regulation

Figure 5. Output Voltage1 vs Output Current1 IOUT2=30mA, IOUT3=50mA

Figure 7. Output Voltage3 vs Output Current1 IOUT2=30mA, IOUT3=50mA

Figure 8. Efficiency vs Output Current1 IOUT2=30mA, IOUT3=50mA

2. **Line regulation**

Figure 13. Output Voltage1 vs Input Voltage IOUT1=100mA, IOUT2=100mA, IOUT3=300mA

Figure 14. Output Voltage2 vs Input Voltage IOUT1=100mA, IOUT2=100mA, IOUT3=300mA

Figure 16. Frequency vs Input Voltage IOUT1=100mA, IOUT2=100mA, IOUT3=300mA

3. Switching waveform

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Figure 17. MOSFET Waveform Vin = 12 V, IOUT1,3 = 0.1 A, IOUT2 = 0.05 A

4. Load response waveform

Figure 19. Load response

Vin = 12 V, IOUT2 = 0.05 A, IOUT3 = 0.1 A IOUT1 = 30 mA to 300 mA

5. Output ripple voltage waveform

Figure 21. Output voltage ripple Waveform VIN = 12 V / IO1,2,3=0.1, 0.05, 0.1 A

R)

Figure 18. MOSFET Waveform Vin = 12 V, IOUT1,3 = 0.3 A, IOUT2 = 0.1 A

6. Startup/stop waveform

7. Output short waveform

R)

Figure 23. Start Up Waveform **Figure 24. Shut Down Waveform**

Vin = $8 V$

Vin = $8 V$

Component surface temperature

Figure 29. Surface Temperature Vin = 8 V, IOUT1 = 0.3 A, IOUT2 = 0.1 A IOUT3 = 0.3 A (Ta = 25℃)

Table 1. Tj Calculation

Figure 30. Surface Temperature Reference

Figure 31. Peak Current Waveform Vin = 8 V, IOUT1 = 0.3 A, IOUT2 = 0.1 A $IOUT3 = 0.3 A$

Tj calculation of IC is calculated using the above table.

Loss of IC is divided into 1: Turn on loss, 2: conduction loss, 3: Turn off loss, and 4: ICC.

Calculate the loss according to Table1 from the actual current waveform and power supply spec.

In this case, Tj is estimated to be 39 °C because Tc = 30.3 °C and Δ Tj = 7.41 °C.

Tj should be designed to be 150 °C or less.

In this case, when Ta = 125 °C, Tj = 146 °C, and Tj = 150 °C is not reached, so it can be judged that there is no problem in the whole temperature range.

Circuit diagrams

(Condition) $V_{IN} = 8 V$ to 32 V, $V_{OUT} = 16.5 V$, 0.2 A

Figure 32. BD7F205EFJ-EVK-001 Schematic

Bill of Materials

*Parts are subject to change without notice.

Transformer specifications

Manufacturer : Sumida Electric Co., Ltd.

 https://job.mynavi.jp/conts/n/sp/23/54430_23sumida/

Product name: CEFD2010-00399-T381R

External Dimensions

◼ Recommended Land

■ Terminal connection diagram

"S"印は巻始めを示す。

"S" indicates the winding start.

" ." Indicates the same polarity.

□印はチューブにて絶縁処理すること。
□ shall be insulated by tube. 端子1-2間及び5-6間はパターンにより接続してご使用下さい。 Pin 1-2 , Pin 5-6 should be connected together when using on PCB.

Transformer Specifications-continued

■ Winding wire and linear/linear type

■ ELECTRICAL CHARACTERISTICS

※ 耐電圧の規格に対して、1.2倍の電圧値で2秒間にて全数検査実施致します。

As to withstand voltage, every part should be tested with 1.2 times of standard voltage for 2 seconds.
※ 飽和電流: インダクタンスが公称値の90 %に減少するときの直流電流の値。

Saturation current: The value of DC current when the inductance decreases to 90% of the nominal value.

Application Design Example

1. Transformer design

1.1 Determining the volume ratio NP/N^S

The winding ratio is a parameter that sets the output voltage, maximum output power, duty, and SW terminal voltage.

The duty of the flyback converter is calculated by the following equation:

$$
Duty = \frac{\frac{N_P}{N_S} \times (V_{OUT} + V_F)}{V_{IN} + \frac{N_P}{N_S} \times (V_{OUT} + V_F)}
$$
 [%)

 N_P : Primary transformer turns

 $N_{\rm c}$: Secondary transformer turns

 V_{OUT} : Output voltage (Since there are 3 outputs, the design is based on output voltage 1)

 V_F : Forward voltage of the output diode on the secondary side

 V_{IN} : VIN pin voltage

From the above formula, the winding ratio is calculated as follows.

$$
\frac{N_P}{N_{S1}} = \frac{D_{TYP}}{1 - D_{TYP}} \times \frac{V_{IN}}{V_{OUT} + V_F}
$$

$$
D_{typ} \qquad : \text{Duty at VIN Voltage (Typ)}
$$

It is recommended to set D_{TYP} from 30% to 50% at the VIN voltage in the middle of the operating range. Initially, set D_{TYP} = 40 %. (This time, set the Duty to 35%)

In this case, the following formula is used.

$$
\frac{N_P}{N_{S1}} = \frac{0.35}{1 - 0.35} \times \frac{12V}{6.2V + 0.6V} = 0.92
$$

Therefore, we will proceed with designing with a Np/Ns1 of 0.92.

The turn ratio is also limited by the maximum duty D_{MAX} determined from the minimum incoming voltage.

Make sure that D_{MAX} given by the equation below does not exceed 70%. If this is the case, set D_{TYP} so that it becomes smaller. If it exceeds 70 %, the OFF time will be shortened. Therefore, the output voltage may deviate due to deviations in the flyback voltage detection.

$$
\frac{N_P}{N_{S1}} = \frac{D_{MAX}}{1 - D_{MAX}} \times \frac{V_{IN(Min)}}{V_{OUT(Max)} + V_{F(Max)}}
$$

 D_{MAX} : Maximum duty of VIN voltage (Min) condition $V_{OUT(Max)}$: Maximum output voltage (Since there are 3 outputs, the design is based on output voltage 1)

 $V_{F(Max)}$: Forward voltage of secondary diode (Max)

$$
D_{MAX} = \frac{0.92}{\frac{8V}{6.2V + 0.6V} + 0.5} = 0.44 < 0.70
$$

For this reason, there is no problem in this design.

D_{MAX} of this designer is 0.44 and 0.70 or less, so it is judged without any problem.

Determining the Volume Ratio NP/NS-continued

The flyback voltage V_{OR} is calculated by the following equation.

$$
V_{OR} = (V_{OUT} + V_F) \times \frac{N_P}{N_{S1}} \quad [V]
$$

$$
V_{OR} = (6.2V + 0.6V) \times 0.92 = 6.3 V
$$

Set so that the SW terminal voltage calculated below does not exceed the withstand voltage.

$$
V_{SW} = V_{IN(Max)} + V_{OR} + V_{SURGE}
$$

For example, if the derating against the SW pin withstand voltage is 90 %, the SW terminal voltage,

 $60 V \times (100 \% - 10 \%) = 54 V$ It should be designed to be within 54 V.

This is designed with $V_{IN(Max)} = 32$ V, $V_{OR} = 6.3$ V.

VSURGE at this time is as follows.

$$
54V - (32V + 6.3V) = 15.7V
$$

Therefore, the surge voltage must be less than 15.7 V.

V_{SURGE} is caused by the leaking magnetic fluxes of the transformers.

If V_{SURGE} is large, the transformer structure needs to be reviewed and the snubber circuitry needs to be adjusted.

1.2 Calculating LP, L^S

Set L_P, L_s to enable continuous current mode operation.

Determine by using the current continuous-mode depth k to obtain L_P, L_s.

k is expressed from Ispk, Is of Figure 32 by the following equation.

 $k = (I_{SPK} - I_{SB})/I_{SPK}$

 I_{spk} : Secondary transformer peak current

 I_{sb} : Secondary transformer bottom current

 K : Constant representing the depth of the current continuous mode (When designing, use $k = 0.25$ as a guide.)

 I_{nb} : Primary transformer bottom current

Transformer design-continued

The maximum peak current on the primary side of the IC is determined by ILIMIT of electrical characteristics.

ILIMIT minimum-value determines the secondary min-peak current Ispk1(Min).

$$
I_{SPK1(Min)} = I_{LIMIT(Min)} \times \frac{N_P}{N_S}
$$
 [A]

The secondary peak current $I_{SPK2(Max)}$ is calculated from the maximum output current $I_{OUT(Max)}$ by the following equation.

$$
I_{SPK2(Max)} = \frac{2 \times I_{OUT(Max)}}{(1 - D_{MAX}) \times (2 - k)} \times \frac{1}{\eta}
$$
 [A]

 η : Use a power supply efficiency of 70 % as a guideline.

 $I_{OUT(Max)}$: Max. secondary output current (Determined by maximum power of 3 outputs ÷ output voltage 1)

 $I_{\text{SPK2(Max)}} < I_{\text{SPK1(Min)}}$ must be met in order for $I_{\text{OUT(Max)}}$ to be printed.

If the conditions cannot be satisfied, change k to redesign. With higher k values in discontinuous mode The operating load area becomes wider. When $k = 1$, discontinuous mode operation is performed in all areas. This IC is continuous

A low k-value is recommended to achieve high-speed response and low EMI characteristics by mode operation. Even if the k value is high, there is no problem with power supply operation.

The secondary-side index $L_{S(Max)}$ is calculated by the following equation.

$$
L_{S(Max)} = \frac{(2-k) \times (V_{OUT} + V_F) \times (1 - D_{MAX})^2}{2 \times I_{OUT(Max)} \times f_{sw(Max)} \times k} \quad [\mu \text{H}]
$$

$$
L_{S(Max)} = \frac{(2 - 0.25) \times (6.2V + 0.6V) \times (1 - 0.44)^2}{2 \times 0.85 \times 430kHz \times 0.25} = 21 \mu H
$$

 $f_{SW(Max)}$: Switching frequency This switching frequency should be calculated at 430 kHz.

 $I_{OUT(Max)}$: Max. secondary output current (Determined by maximum power of 3 outputs ÷ output voltage 1)

At this time, the primary inductance Lp is obtained by the following equation.

$$
L_P = L_S \times (\frac{N_P}{N_S})^2
$$
 [µH]

$$
L_P = 21 \mu H \times (0.92)^2 = 18 \mu H
$$

From the above, we will proceed with the design as Lp:18μH, Ls:21μH in this design.

2. Output voltage

When the built-in switching MOSFET is turned OFF, the SW pin voltage Vsw becomes higher than the VIN pin voltage. Since the difference between the SW pin voltage and the VIN pin voltage is equal to the primary flyback voltage, the secondary output voltage is calculated from this voltage. The SW pin voltage Vsw at turn-off is calculated by the following equation.

$$
V_{SW} = V_{IN} + \frac{N_P}{N_S} \times (V_{OUT} + V_F)
$$
 [V]

 V_{SW} : SW pin voltage

 V_{IN} : VIN pin voltage

- N_P : No. of primary transformer turns
- $N_{\rm S}$: Secondary transformer turns
- V_{OUT} : Output voltage
- V_F : Forward voltage of the output diode on the secondary side

Figure 35. Application Block Diagram

The primary flyback voltage is converted to the FB-pin inrush current I_{FB} by the external resistor R_{FB} between FB-SW terminals. Since the FB pin voltage becomes almost equal to the VIN pin voltage by the IC's internal circuit, the FB pin inrush current IRFB is calculated by the following equation.

$$
I_{FB} = \frac{V_{SW} - V_{FB}}{R_{FB}} = \frac{V_{IN} + \frac{N_P}{N_S} \times (V_{OUT} + V_F) - V_{FB}}{R_{FB}} = \frac{\frac{N_P}{N_S} \times (V_{OUT} + V_F)}{R_{FB}}
$$
[A]

 I_{FB} : FB pin inrush current

 V_{FB} : FB terminal voltage

 R_{FB} : External resistor between FB and SW pins

2. Output Voltage- continued

In addition, since the FB pin inrush current IRFB flows to the external resistor RREF between the REF terminal and GND terminal, the REF terminal voltage is calculated by the following equation.

$$
V_{REF} = \frac{R_{REF}}{R_{FB}} \times \frac{N_P}{N_S} \times (V_{OUT} + V_F)
$$
 [V]

 V_{REF} : REF pin voltage

 R_{REF} : External resistor between REF pin and GND pin

Because the current that flows to the REF pin becomes IREF when the REF pin voltage is VINTREF for RREF,

 $R_{REF} = \frac{0.54V}{200 \mu A}$ $\frac{1}{200\mu A}$ = 2.7 *ksl* The resistor must be set.

The REF pin voltage is input to the comparator with the reference voltage inside the IC. The REF pin voltage is equal to the reference voltage by the internal circuit of the IC. Therefore, the output voltage and the REF pin voltage are calculated by the following equations.

$$
V_{OUT} = \frac{R_{FB}}{R_{REF}} \times \frac{N_S}{N_P} \times V_{INTER} - V_F
$$
\n^[V]

As can be seen from this equation, the output voltage V_{OUT} can be set by the transformer turn ratio (N_P/N_S) on the primary and secondary sides and the resistance ratio between RFB and RREF.

From the above equation, the external resistor RFB between the FB pin and SW terminal can be calculated by the following equation.

$$
R_{FB} = \frac{R_{REF}}{V_{INTER}} \times \frac{N_P}{N_S} \times (V_{OUT} + V_F)
$$
 [Ω]

In this designer, R_{FB} is determined as follows.

$$
R_{FB} = \frac{2.7k\Omega}{0.54V} \times 0.94 \times (6.2V + 0.6V) = 31.96 k\Omega
$$

 R_{FB} is set to 31.6kohm.

However, the ESR on the secondary side of the transformer is a factor that lowers the output voltage as in V_F of the above equation.

Also, when the transformer is not coupled, the number of turns of N_P/N_S is shifted, which causes the output voltage to decrease.

Therefore, finally adjust the output voltage by checking the actual device.

RFB has been decided, let's decide the winding ratios of the other output transformers.

Since Np/Ns1 is 0.92, we designed Np=11T and Ns1=12T.

At this time, the formula for output voltage 2 is as follows.

$$
V_{OUT} = \frac{R_{FB}}{R_{REF}} \times \frac{N_{S2}}{N_P} \times V_{INTERF} - V_F
$$

Therefore, Ns2=31T. Determine Ns3 as 12T by the same formula.

3. Output Capacitor

Place the output capacitor as close to the secondary diode as possible. The output capacitance value C_{OUT} is set from the output ripple voltage ΔV_{O} and the start-up time. The output ripple voltage generated by one switching is calculated as follows.

$$
\Delta V_O = \frac{I_{OUT(Max)} \times D_{MAX}}{f_{SW(Max)} \times C_{OUT}} \tag{V}
$$

On the other hand, when output capacitor is large, start-up time is long.

When SCP detection mask time (t_{MASKSCP}) in start-up is passed, if REF voltage is lower than Vsc_P, power supply cannot output. Therefore, C_{OUT} must be satisfied below condition.

$$
C_{OUT} \leq \frac{1}{2} \times \frac{t_{MASKSCP(Min)} \times \{ (l_{LIMIT(Min)} \times \frac{N_p}{N_S}) \times (1 - Duty) - l_{OUT(Max)} \}}{V_{OUT} \times (\frac{V_{SCP(Max)}}{V_{INTREF(Min)})}
$$
 [µF]

Where
$$
\frac{V_{SCP(Max)}}{V_{INTERF(Min)}} = 0.762
$$

A large capacitor capacitance value is required to hold the output voltage during load response or power supply voltage response.

A capacitance value of 20 μF or more is recommended as a guideline for the output voltage capacitance.

Ceramic capacitors are affected by temperature characteristics, capacitance variation, DC bias characteristics, etc. The capacitance value may decrease. Pay attention to these points when selecting parts.

4. Input Capacitor

Use a ceramic capacitor for the input capacitor and place it as close to the IC as possible. Capacitance of the capacitor should be 10 μF or more.

5. Secondary output diode

A Schottky barrier diode or a fast recovery diode with low V_F is recommended because the forward voltage V_F of the secondary output diode causes an error in the output voltage. When selecting a secondary output diode, the peak of the secondary reverse voltage must not exceed the rating of the diode. The secondary RMS current I_{SRMS} must also be set so that it does not exceed the rating.

Generally, 30 % or more of the reverse-direction breakdown voltage V_R is recommended.

$$
V_R = (V_{IN(Max)} \times \frac{N_S}{N_P} + V_{OUT}) \times 1.3 + V_{SURGE}
$$
 [V]

 V_R : Reverse voltage of the secondary output diode

 $V_{IN(Max)}$: VIN pin maximum voltage

 N_P : No. of primary transformer turns

 N_c : Secondary transformer turns

 V_{OUT} : Output voltage

 V_{SURGE} : Transformer surge voltage generated in the diode

It is recommended that the rated current of the secondary output diode be at least twice that of IsRMS.

6. Output Resistance and Zener Diode (Minimum Load Current)

The output voltage rises when no load is applied or when light load is applied. The reason for this is that the MAXIMUM is in the OFF-time toff MAX when the IC is under light load.

This is because switching is always performed at the minimum frequency determined by the minimum ON-time ton MIN. For the power Po_MIN determined by the switching frequency of this lowest frequency, when the secondary load is lighter than this, the output voltage is

It moves up. P_O $_{MIN}$ is calculated by the following equation:

$$
P_{O_MIN} = \frac{V_{IN(Max)}^{2}}{2 \times L_{P}} \times t_{ON_MIN(Max)}^{2} \times \frac{1}{t_{ON_MIN(Max)} + t_{OFF_MAX(Min)}} \text{ [W]}
$$

$$
I_{OUT_MIN} = \frac{P_{O_MIN}}{V_{OUT}}
$$
 Because it is an expression, it can also be obtained from I_{OUT_MIN} .

If the rise in the secondary output voltage becomes a problem, connect a secondary output zener diode to suppress the rise in the voltage. It is also necessary to suppress the rise in the output voltage by adding a resistor to the secondary output to provide a constant loss. The output resistor Rout to be connected to the secondary side should be as follows. The resistor-loss $\Pr_{\text{Loss}}[W]$ calculated as follows.

$$
P_{loss} = \frac{v_{OUT}^2}{R_{OUT}} = \frac{v_{OUT}^2}{\frac{v_{INT}}{v_{IN(Max)}^2} \times t_{ON_MIN(Max)}^2 \times \frac{v_{OUT}^2}{t_{ON_MIN(Max)} + t_{OFF_MAX(Min)}}}
$$

In practice, even if R_{OUT} loads calculated by the above equation are used, the output voltage rises transiently during secondary discharging. Therefore, it should be set lower enough than this Rout. Adjust this resistance value in the actual evaluation. When selecting a resistor, pay attention to the rated power of the resistor.

7. Snubber circuit

Excessive on the SW pin at turn-off when the degree of coupling of the transformer is low or the large current line of the board is long, etc.

Voltage may be applied.

To suppress this, use the snubber circuitry indicated by Figure 34.

This snubber circuit clamps the voltage when the flyback voltage + surge voltage exceeds this snubber voltage.

The clamping voltage is determined by the following equation.

 $V_{CLAMP} = V_{F2} + V_{Z}$

 V_{CLAMP} : Clamp setting voltage of snubber

 V_{F2} : Forward voltage of the Schottky diode

 V_{τ} : Zener voltage of the zener diode

At turn-off if the clamp setting voltage is lower than the flyback voltage $\frac{N_P}{N}$ $\frac{N_T}{N_S} \times (V_{OUT} + V_F)$

A current flows through the zener. Therefore, be sure to set a voltage higher than the flyback voltage.

[V]

In addition, the snubber circuit may not be clamped at the set clamping voltage because of its operational responsiveness.

Therefore, be sure to check the clamp voltage in actual operation.

8. SDX/EN terminal resistor

8.1 Setting Enable Voltage

After releasing VIN UVLO, Enable voltage V_{IN} ENABLE can be set by the following equation.

$$
V_{IN_ENABLE} = V_{EN1} \times \frac{R_1 + (R_2 // R_{SDX/EN})}{R_2 // R_{SDX/EN}}
$$
 [V]

 $V_{IN\ ENABLE}$: Target operations start VIN voltage

 V_{EN1} : Enable volt1

 R_2 // $R_{SDX/EN}$: Partial pressure resistance between R₂ and R_{SDX/EN} inside the ICs

8.2 Setting Disable Voltage

Disable voltage V_{IN} DISABLE when the VIN pin voltage falls can be set by the following equation.

$$
V_{IN_DISABLE} = V_{EN2} \times \frac{R_1 + (R_2 // R_{SDX/EN})}{R_2 // R_{SDX/EN}}
$$
 [V]

 $V_{IN\ DISABLE}$: Intended operation stop VIN voltage

 V_{EN2} : Enable volt2

9 Output voltage compensation function using L_COMP pin resistor

The IC can compensate for the voltage drop in the output voltage V_{OUT} in response to the increase in IP of the primary transformer peak current.

 V_{OUT} changes can be caused by V_F variations in the secondary diodes or by leaking magnetic fluxes in the transformer. An example of the output voltage compensation function is shown in Figure 35.

Figure 37. L_COMP voltage compensation example

This function compensates the output voltage by adding a IREFCOMP current to the REF current that determines the output voltage.

$$
V_{OUT} = R_{FB} \times \frac{N_S}{N_P} \times \left(\frac{V_{INTER}}{R_{REF}} + I_{REFCOMP}\right) - V_F
$$
 [V]

 $\frac{V_{INTERF}}{R_{REF}}= 200~\mu A~(Typ)$ Fixed value. I $_{REF}$ comp is incremented relative to the primary current. R_{BFF}

As a result, the output voltage is compensated according to the load current on the secondary side.

IREFCOMP is determined by the following equation.

$$
I_{REFCOMP} = R_{L_COMP} \times K_{L_COMP} \times I_{SW(Ave)} \tag{µA}
$$

9 Output Voltage Compensation by L_COMP Pin Resistor-continued

The mean current Isw(Ave) of the SW pin can be converted into the following equation.

$$
I_{SW(Ave)} = I_{S(Ave)} \times \frac{N_S}{N_P} = I_{OUT} \times \frac{1}{\eta} \times \frac{N_S}{N_P}
$$
 [A]

 η : Efficiency (Designed at about 70% and adjust R_{L COMP} in the application assessment.)

As shown in this equation, $I_{SW(Ave)}$ is proportional to I_{OUT} , so you can compensate for the above. The compensation amount can be adjusted by the resistance value of the L_COMP pin. Since ISW is a triangle-wave current, always use a capacitor of 0.1 μF or more at the L_COMP pin to smooth this. Please connect.

The resistor of the L_COMP pin is calculated by the following equation.

$$
R_{L_COMP} = \frac{I_{REFCOMP}}{I_{SW(Ave)}} \times \frac{1}{K_{L_COMP}}
$$
 [kΩ]

Be sure to check the output voltage characteristics in the application evaluation and adjust the L_COMP terminal resistor as necessary.

When compensation is not performed, short the L_COMP pin to GND.

Revision history

Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

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http://www.rohm.com/contact/